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INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

(Chapter II of the Patent Cooperation Treaty)

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference			
P34293-P0	FOR FURTHER A		See Form PCT/IPEA/416
International application No. PCT/JP2004/012672	International filing date 26.08.2004	(day/month/year)	Priority date (day/month/year) 01.09.2003
International Patent Classification (IPC) or n G06F17/60, G06F17/50, G05B19/18	ational classification and 3, H05K13/04	IPC	
Applicant MATSUSHITA ELECTRIC INDSTR	IAL CO., LTD. et al.		
This report is the international pre Authority under Article 35 and trar	liminary examination rensmitted to the applica	eport, established by this nt according to Article 36	s International Preliminary Examining 3.
2. This REPORT consists of a total of			•
3. This report is also accompanied by			
a. 🗆 sent to the applicant and to			s follows:
☐ Sheets of the description	on, claims and/or drawi	ings which have been ar	mended and are the basis of this report see Rule 70.16 and Section 607 of the
☐ sheets which supersed	ie earlier sheets, hut w	rhich this Authority consi Dlication as filed, as indic	ders contain an amendment that goes cated in item 4 of Box No. I and the
b. (sent to the International Bosequence listing and/or tables Box Relating to Sequence I	les relateu merein on c	OMINITER RESIDENCE FORM	r of electronic carrier(s)) , containing a only, as indicated in the Supplemental nstructions).
4. This report contains indications rel	to the following it		
-	_	ems:	•
⊠ Box No. I Basis of the opin	ilon		
☐ Box No. il Priority ☐ Box No. III Non-establishme			
K7	ent of opinion with rega	rd to novelty, inventive s	step and industrial applicability
☐ Box No. V Reasoned staten	nent under Article 35/2	o) with record to novelly	Inventive step or industrial
applicability; cital	lions and explanations	supporting such statem	inventive step or industrial ent
☐ Box No. VI Certain documen	nts cited		
☐ Box No. VII Certain defects in	n the international appl	ication	
☐ Box No. VIII Certain observati	ions on the internation	al application	
Date of submission of the demand		Date of completion of this	report
31.01.2006		22.02.2006	
Name-and mailing address of the international preliminary examining authority:	ı	Authorized Officer	and Politica
European Patent Office			M. &
D-80298 Munich Tel. +49 89 2399 - 0 Tx: 523656	6 epmu d	Sohrt, W	(0)) }
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-	 -	
_	Box No. I	Basis of the report
1.	. With regard filed, unless	d to the language, this report is based on the international application in the language in which it was something to the something the sound of t
	WITHOUT	eport is based on translations from the original language into the following language , is the language of a translation furnished for the purposes of:
	☐ inte ☐ pub	ernational search (under Rules 12.3 and 23.1(b)) Dication of the international application (under Rule 12.4) ernational preliminary examination (under Rules 55.2 and/or 55.3)
2.		d to the elements* of the international application, this report is based on <i>(replacement sheets which furnished to the receiving Office in response to an invitation under Article 14 are referred to in this priginally filed" and are not annexed to this report):</i>
	Description,	, Pages
	1-35	as originally filed
	Claims, Num	nbers
	1-16	received on 31.01.2006 with letter of 31.01.2006
	Drawings, S	heets
	1/25-25/25	as originally filed
	□ a seque	ence listing and/or any related table(s) - see Supplemental Box Relating to Sequence Listing
3.		nendments have resulted in the cancellation of:
	☐ the o	description, pages claims, Nos.
	☐ the c	drawings, sheets/figs sequence listing <i>(specify)</i> :
	☐ any f	table(s) related to sequence listing (specify):
	Supplementa	port has been established as if (some of) the amendments annexed to this report and listed below n made, since they have been considered to go beyond the disclosure as filed, as indicated in the all Box (Rule 70.2(c)).
	☐ the c	description, pages claims, Nos.
	☐ the d ☐ the s	drawings, sheets/figs requence listing <i>(specify)</i> :
	□ any t	table(s) related to sequence listing (specify):
	* If ite	m 4 applies, some or all of these sheets may be marked "supercoded"

INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

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	Box No. III Non-establishment of opinion with regard to novelty, inventive step and industrial					
	applicability					
١.	The questions whether the claimed invention appears to be novel, to involve an inventive step (to be non-bylous), or to be industrially applicable have not been examined in respect of:					
	☐ the entire international applicatio	the entire international application,				
	l claims Nos. 15					
	because:					
I	the said international application, or the said claims Nos. relate to the following subject matter which does not require an international preliminary examination (specify):					
I	the description, claims or drawings (indicate particular elements below) or said claims Nos. are so unclear that no meaningful opinion could be formed (specify):					
[the claims, or said claims Nos. are so inadequately supported by the description that no meaningful opinion could be formed.					
Ē	no international search report has been established for the said claims Nos. 15					
[the nucleotide and/or amino acid sequence listing does not comply with the standard provided for in Annex C of the Administrative Instructions in that:					
	the written form		has not been furnished			
	[does not comply with the standard			
	the computer readable form		has not been furnished			
	Γ	_	does not comply with the standard			
	the tables related to the nucleotide and/or amino acid sequence listing, if in computer readable form only, do not comply with the technical requirements provided for in Annex C-bis of the Administrative Instructions.					
E	See separate sheet for further de	tail	s			

INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

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_	-	11 11					
_	Box No. IV Lack of unity of invention						
1.	×	□ restri □ paid □ paid	nse to the invitation t cted the claims. additional fees. additional fees under er restricted nor paid	· protes	st.	ditional fees, the applicant has:	
2.		This Aut Rule 68.	hority found that the 1, not to invite the ap	require plicant	ement of unit to restrict o	y of invention is not complied with and chose, according to r pay additional fees.	
3.	This	s Authorit	y considers that the r	equire	ment of unity	y of invention in accordance with Rules 13.1, 13.2 and 13.3	
		complied	l with.				
	\boxtimes	not comp	olied with for the follo	wing re	easons:		
		see sepa	arate sheet				
4.	Con	sequently	, this report has bee	n estal	olished in res	spect of the following parts of the international application:	
		all parts.					
	Ø	the parts	relating to claims No	s. 1-14	4,16 .		
		No. V licability	Reasoned statemer citations and explanations	nt und anatio	er Article 3 ns supporti	5(2) with regard to novelty, inventive step or industrial ng such statement	
1.	State	ement					
	Nove	elty (N)		Yes: No:	Claims Claims	1-14,16	
	Inve	ntive step	(IS)	Yes: No:	Claims Claims	1-14,16	
	Indu	strial app	licability (IA)	Yes: No:	Claims Claims	1-14,16	
,	O:1-1		- 1 11 15 15 15				

2. Citations and explanations (Rule 70.7):

see separate sheet

Re Item III.

Non-establishment of opinion with regard to novelty, inventive step and industrial applicability

Claim 15 does not meet the requirements of Article 6 PCT in that the matter for which protection is sought is not clearly defined.

Claim 15 claims a mounter, but the features of claim 15 are regarding the mounting order the mounter receives, i.e. the mounter of claim 15 cannot be decided from a conventional mounter.

The question of whether the claimed invention appears to be novel, to involve an inventive step, or to be industrially applicable has not been and will not be the subject of the international preliminary examination in respect of the claims which have not been searched (Art. 17(2)(a) or (3) and Rule 66.1(e) PC, see also international search report).

Re Item IV.

Lack of unity of invention

The separate inventions/groups of inventions are:

1-2,13,14,16

Optimizing an order of component mounting for a plurality of mounters via identical sub-board patterns; optimizing the order of component mounting for any one pattern

3-10

Adding a number determination step for the number of patterns to be allocated to each mounter

11-12

Optimization by making distances uniform

They are not so linked as to form a single general inventive concept (Rule 13.1 PCT) for the following reasons:

Claim 1 is not inventive over prior art document D1, as explained in 2.1 below. The additional features of each claim of group 1 do not form an inventive general concept with any claim from group 2 or group 3.

Since the applicant has paid further fees for groups 2 and 3, all groups will be treated below.

Re Item V.

1 Reference is made to the following documents:

D1: EP-A-1 227 711 (MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD) 31 July 2002 (2002-07-31)

2 INVENTIVE STEP GROUP 1

2.1 The solution proposed in claim 1 of the present application does not involve an inventive step (Article 33(3) PCT) for the following reasons:

Document D1, which is considered to represent the most relevant state of the art, discloses (the references in parentheses applying to this document):

 An optimization method for optimizing an order of component mounting in a component mounting system having a plurality of placement heads for mounting components on a board

(§[0084] " In this improved step repeat method, the order of mounting of electronic

components is similar to that of the conventional step repeat method as shown in Fig. 7, where the mounting is carried out in the order of chip components -> SOPS -> QFPs as shown by arrows in Fig. 7. More specifically, as placement steps are shown sequentially in Fig. 8, the first steps include sucking up the chip component C1 to the first placement head 38a, the chip component C5 to the second placement head 38b, and the chip component C9 to the third placement head 38c by S-size suction nozzles, respectively, all simultaneously or each individually, moving the transfer head 28, and placing the chip components C1, C5, C9 onto the respective sub-boards in this order"),

wherein a plurality of patterns having the same component placement structure is included in the board

(§[0056] "Fig. 7 is a view showing an order of placement by an improved step repeat method in an example of a multiple board composed of three sub-boards having an identical pattern"),

and

the optimization method comprises an allocation step of allocating components, to each of the plurality of mounters, on a per pattern basis

(§[0084] same passage as above; Fig. 8 - all components of the first pattern ("SUB-BOARD" 1) are allocated to mounter ("PLACEMENT HEAD") 1, all of the second pattern to mounter 2, and all of the third pattern to mounter 3)

The difference of claim 1 over the teaching of D1 is that

where D1 disclosing having multiple "placement heads", claim 1 talks about multiple "mounters" instead.

However, to a skilled person it is known that "multiple mounters" is a general term encompassing independently moving mounters as well as multiple mounters that are fixed relatively to each other and operate with synchronous movement, such as "placement heads" in D1.

Therefore, choosing "multiple mounters" instead of "placement heads" is a choice among obvious design options that a skilled person would take upon circumstances, thus arriving at a solution as set out in claim 1 without using inventive activity. Choosing one option over the other does not achieve any surprising technical effect.

2.2 Dependent claim 2 is not considered inventive (Article 33(3) PCT) because optimizing the order of component mounting for any one pattern among the plurality of patterns

is implied by D1 (same passage of §[0084] as cited above).

2.3 Independent claims 13,14, and 16 are not considered inventive (Article 33(3) PCT) for the same reason as claim 1.

3 INVENTIVE STEP GROUP 2

3.1 Dependent claims 3-6 are not considered inventive (Article 33(3) PCT) for the following reason:

A skilled person, implementing the system described in 1.1 above for the common case that there are more patterns than mounters, would have to distribute the patterns to the mounters in an efficient way.

- It is obvious that the patterns should be distributed as evenly as possible to the mounters in order to achieve a balanced load. Therefore, claim 3 is not inventive.
 - If there are remaining patterns after distributing an equal number of patterns to each mounter as far as possible, there are two choices what to do with them:
- either distributing the remaining patterns to one mounter each, thus arriving at the solution of claim 4,
- or splitting up the remaining patterns into sub-structures that are to be treated by the mounters individually, thus arriving at the solution of claims 5 and 6.
- 3.2 Claim 7 is not considered inventive (Article 33(3) PCT) because it is obvious that said sub-structures of 3.1 should be distributed in a load-balancing way to the mounters, i.e. that the mounting times are approximately equal.
- 3.3 Claim 8 is not considered inventive (Article 33(3) PCT) because a skilled person would avoid placing patterns such that they cannot be reached by any of the plurality of mounters, i.e. patterns would always be placed at "positions in the board on which

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components can be mounted by said plurality of mounters"

N.B.:

Possibly the wording "on which components can be mounted by said plurality of mounters" was meant to be "on which components can be mounted by *each of* said plurality of mounters"?

4. INVENTIVE STEP GROUP 3

4.1 Claims 11 and 12 are not considered inventive (Article 33(3) PCT) because when implementing the "simultaneously" moving mounting heads of D1 (§[0084]), uniform distances from default positions to the patterns and from placement positions to the placement positions are a logical consequence.

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What is claimed is:

1. (Amended) An optimization method for optimizing an order of component mounting in a component mounting system having a plurality of mounters for mounting components on a board,

wherein a plurality of patterns having the same component placement structure is included in the board, and

the optimization method comprises an allocation step of allocating components, to each of the plurality of mounters, on a per pattern basis or per pattern group which is made up of a plurality of patterns.

- 2. The optimization method according to Claim 1, further comprises a step of optimizing the order of component mounting for any one pattern among the plurality of patterns.
- The optimization method according to Claim 1, wherein the allocation step includes:

a pattern number determination step of determining, from a total number of the patterns included in the board and a number of the mounters, a number of patterns to be allocated to each of the mounters so that the number of patterns is approximately even; and

a pattern allocation step of allocating the determined number of patterns to any of the plurality of mounters for component mounting.

- 4. The optimization method according to Claim 3, wherein the pattern number determination step includes:
- a step of calculating a quotient and a remainder by dividing the total number of the patterns included in the board by the number of mounters;

a step of determining the quotient as the number of patterns

to be allocated, in the case where the remainder is zero; and

a step of i) determining a number, which is the quotient plus one, as the number of patterns to be allocated to the same number of mounters as the remainder, starting from the mounter in a process farthest upstream, and ii) determining the quotient as the number of patterns to be allocated to the rest of the mounters, in the case where the remainder is one or greater.

- 5. The optimization method according to Claim 3, wherein the pattern number determination step includes:
- a step of calculating a quotient and a remainder by dividing the total number of the patterns included in the board by the number of mounters; and
- a first allocation sub-step of determining the quotient as the number of patterns to be allocated to each of the mounters.
- 6. The optimization method according to Claim 5, wherein the pattern number determination step further includes a second allocation sub-step of determining the remainder as the number of patterns to be commonly allocated to the plurality of mounters.
- 7. The optimization method according to Claim 6, wherein in the second allocation sub-step, the number of patterns to be commonly allocated to the plurality of mounters is determined so that a time for component mounting for each of the mounters is approximately even.
- 8. The optimization method according to Claim 6,
 wherein in the pattern allocation step, the patterns to be commonly allocated to the plurality of mounters are located in positions in the board on which components can be mounted by said

plurality of mounters.

- 9. The optimization method according to Claim 6, wherein the plurality of mounters is all of the mounters included in the component mounting system.
- The optimization method according to Claim 3, wherein in the pattern allocation step, the determined number of patterns are allocated to each of the mounters, as the patterns on which components are to be mounted, so that borders between the determined number of patterns allocated to each of the mounters are set orthogonally to a direction in which the board moves.
- 11. The optimization method according to Claim 1, further comprises a step of determining a position of the board during component mounting so that a moving distance, from a default position to the allocated pattern, of a head of each of the mounters is uniform for all of said mounters, the head being used for mounting components on the board.
 - 12. The optimization method according to Claim 1, further comprises a step of determining placement positions of component cassettes used in component mounting so that a distance from the placement positions of the component cassettes to the allocated pattern, for each of the mounters is uniform for all of said mounters.
 - 13. (Amended) A program for a component mounting system having a plurality of mounters for mounting components on a board, wherein a plurality of patterns having the same component placement structure is included in the board, and

the program causing a computer to execute an allocation step

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of allocating components, to each of the plurality of mounters, on a per pattern basis or per pattern group which is made up of a plurality of patterns.

14. (Amended) A computer-readable recording medium on which a program for a component mounting system is recorded, the component mounting system having a plurality of mounters for mounting components on a board,

wherein a plurality of patterns having the same component placement structure is included in the board, and

the program causes a computer to execute an allocation step of allocating components, to each of the plurality of mounters, on a per pattern basis or per pattern group which is made up of a plurality of patterns.

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15. (Amended) A mounter for mounting components on a board according to a mounting order optimized through an optimization method for optimizing an order of component mounting in a component mounting system having a plurality of mounters for mounting components on a board,

wherein a plurality of patterns having the same component placement structure is included in the board, and

the optimization method includes an allocation step of allocating components, to each of the plurality of mounters, on a per pattern basis or per pattern group which is made up of a plurality of patterns.

16. (Amended) An optimization apparatus for optimizing an order of component mounting in a component mounting system having a plurality of mounters for mounting components on a board,

wherein a plurality of patterns having the same component placement structure is included in the board, and

the apparatus comprises:

an optimizing unit operable to optimize the order of component mounting for any one pattern among the plurality of patterns; and

an allocating unit operable to allocate components, to each of the plurality of mounters, on a per pattern basis or per pattern group which is made up of a plurality of patterns.